MICROCHIP MCP23008/MCP23S08

8-Bit I/O Expander with Serial Interface

Features

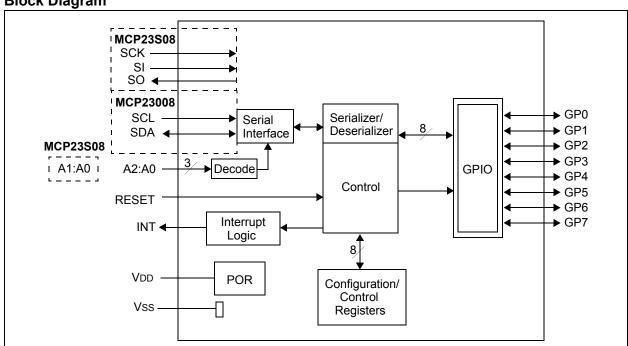
- · 8-bit remote bidirectional I/O port
 - I/O pins default to input
- High-speed I²C[™] interface (**MCP23008**)
 - 100 kHz
 - 400 kHz
 - 1.7 MHz
- High-speed SPI interface (MCP23S08)
 - 10 MHz
- · Hardware address pins
 - Three for the MCP23008 to allow up to eight devices on the bus
 - Two for the MCP23S08 to allow up to four devices using the same chip-select
- · Configurable interrupt output pin
 - Configurable as active-high, active-low or open-drain

- · Configurable interrupt source
 - Interrupt-on-change from configured defaults or pin change
- · Polarity Inversion register to configure the polarity of the input port data
- · External reset input
- Low standby current: 1 μA (max.)
- · Operating voltage:
 - 1.8V to 5.5V @ -40°C to +85°C I²C @ 100 kHz SPI @ 5 MHz
 - 2.7V to 5.5V @ -40°C to +85°C I²C @ 400 kHz SPI @ 10 MHz
 - 4.5V to 5.5V @ -40°C to +125°C I²C @ 1.7 kHz SPI @ 10 MHz

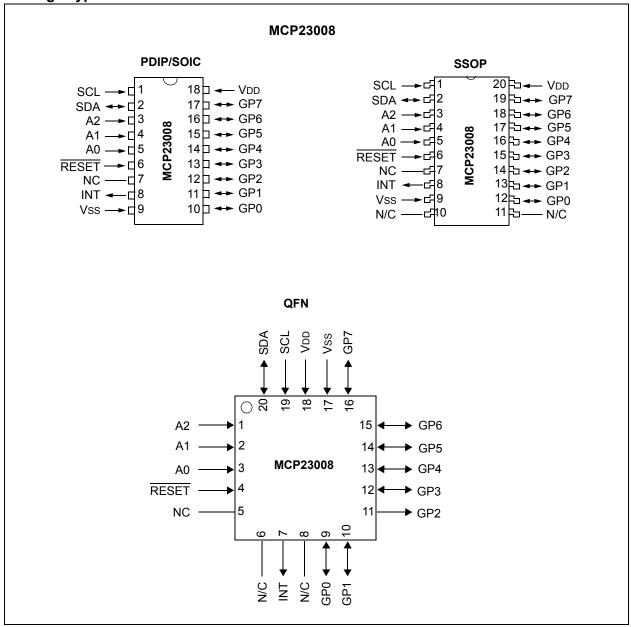
Packages

- 18-pin PDIP (300 mil)
- 18-pin SOIC (300 mil)
- 20-pin SSOP
- 20-pin QFN

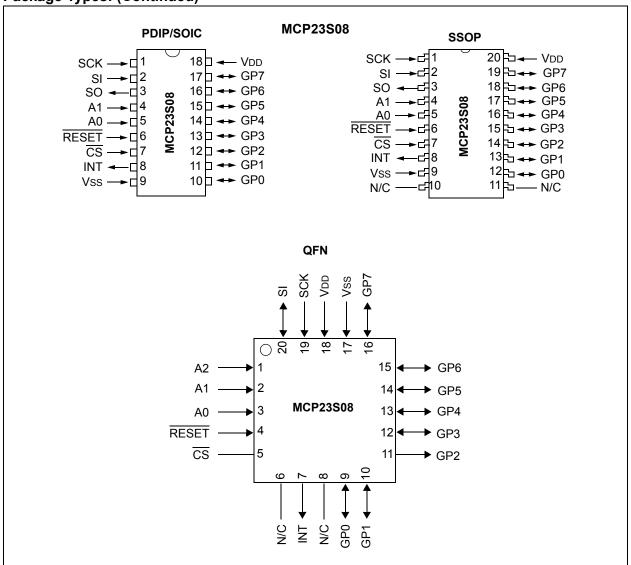
Block Diagram



Package Types



Package Types: (Continued)



NOTES:

1.0 DEVICE OVERVIEW

The MCP23X08 device provides 8-bit, general purpose, parallel I/O expansion for I^2C bus or SPI applications. The two devices differ in the number of hardware address pins and the serial interface:

- MCP23008 I²C interface; three address pins
- MCP23S08 SPI interface: two address pins

The MCP23X08 consists of multiple 8-bit configuration registers for input, output and polarity selection. The system master can enable the I/Os as either inputs or outputs by writing the I/O configuration bits. The data for each input or output is kept in the corresponding Input or Output register. The polarity of the Input Port register can be inverted with the Polarity Inversion register. All registers can be read by the system master.

The interrupt output can be configured to activate under two conditions (mutually exclusive):

- When any input state differs from its corresponding input port register state, this is used to indicate to the system master that an input state has changed.
- 2. When an input state differs from a preconfigured register value (DEFVAL register).

The Interrupt Capture register captures port values at the time of the interrupt, thereby saving the condition that caused the interrupt.

The Power-on Reset (POR) sets the registers to their default values and initializes the device state machine.

The hardware address pins are used to determine the device address.

1.1 Pin Descriptions

TABLE 1-1: PINOUT DESCRIPTION

Pin Name	PDIP/ SOIC	QFN	SSOP	Pin Type	Function
SCL/SCK	1	19	1	ı	Serial clock input.
SDA/SI	2	20	2	I/O	Serial data I/O (MCP23008)/Serial data input (MCP23S08).
A2/SO	3	1	3	I/O	Hardware address input (MCP23008)/ Serial data output (MCP23S08). A2 must be biased externally.
A1	4	2	4	- 1	Hardware address input. Must be biased externally.
A0	5	3	5	1	Hardware address input. Must be biased externally.
RESET	6	4	6	1	External reset input. Must be biased externally.
NC/CS	7	5	7	ı	No connect (MCP23008)/External chip select input (MCP23S08).
INT	8	7	8	0	Interrupt output. Can be configured for active-high, active-low or open-drain.
Vss	9	17	9	Р	Ground.
GP0	10	9	12	I/O	Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor.
GP1	11	10	13	I/O	Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor.
GP2	12	11	14	I/O	Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor.
GP3	13	12	15	I/O	Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor.
GP4	14	13	16	I/O	Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor.
GP5	15	14	17	I/O	Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor.
GP6	16	15	18	I/O	Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor.
GP7	17	16	19	I/O	Bidirectional I/O pin. Can be enabled for interrupt-on-change and/or internal weak pull-up resistor.
VDD	18	18	20	Р	Power.
N/C	_	6, 8	10, 11	_	_

1.2 Power-on Reset (POR)

The on-chip POR circuit holds the device in reset until VDD has reached a high enough voltage to deactivate the POR circuit (i.e., release the device from Reset). The maximum VDD rise time is specified in **Section 2.0** "Electrical Characteristics".

When the device exits the POR condition (releases reset), device operating parameters (i.e., voltage, temperature, serial bus frequency, etc.) must be met to ensure proper operation.

1.3 Serial Interface

This block handles the functionality of the I²C (MCP23008) or SPI (MCP23S08) interface protocol. The MCP23X08 contains eleven registers that can be addressed through the serial interface block (Table 1-2):

TABLE 1-2: REGISTER ADDRESSES

Address	Access to:
00h	IODIR
01h	IPOL
02h	GPINTEN
03h	DEFVAL
04h	INTCON
05h	IOCON
06h	GPPU
07h	INTF
08h	INTCAP (Read-only)
09h	GPIO
0Ah	OLAT

1.3.1 SEQUENTIAL OPERATION BIT

The Sequential Operation (SEQOP) bit (IOCON register) controls the operation of the address pointer. The address pointer can either be enabled (default) to allow the address pointer to increment automatically after each data transfer, or it can be disabled.

When operating in **Sequential mode** (IOCON.SEQOP = 0), the address pointer automatically increments to the next address after each byte is clocked.

When operating in **Byte mode** (IOCON.SEQOP = 1), the MCP23X08 does not increment its address counter after each byte during the data transfer. This gives the ability to continually read the same address by providing extra clocks (without additional control bytes). This is useful for polling the GPIO register for data changes.

1.3.2 I²C™ INTERFACE

1.3.2.1 I²C Write Operation

The I²C Write operation includes the control byte and register address sequence, as shown in the bottom of Figure 1-1. This sequence is followed by eight bits of data from the master and an Acknowledge (ACK) from the MCP23008. The operation is ended with a STOP or RESTART condition being generated by the master.

Data is written to the MCP23008 after every byte transfer. If a STOP or RESTART condition is generated during a data transfer, the data will not be written to the MCP23008.

Byte writes and sequential writes are both supported by the MCP23008. The MCP23008 increments its address counter after each ACK during the data transfer.

1.3.2.2 I²C Read Operation

The I^2C Read operation includes the control byte sequence, as shown in the bottom of Figure 1-1. This sequence is followed by another control byte (including the START condition and ACK) with the R/W bit equal to a logic 1 (R/W = 1). The MCP23008 then transmits the data contained in the addressed register. The sequence is ended with the master generating a STOP or RESTART condition.

1.3.2.3 I²C Sequential Write/Read

For sequential operations (Write or Read), instead of transmitting a STOP or RESTART condition after the data transfer, the master clocks the next byte pointed to by the address pointer (see **Section 1.3.1 "Sequential Operation Bit"** for details regarding sequential operation control).

The sequence ends with the master sending a STOP or RESTART condition.

The MCP23008 address pointer will roll over to address zero after reaching the last register address.

Refer to Figure 1-1.

1.3.3 SPI INTERFACE

1.3.3.1 SPI Write Operation

The SPI Write operation is started by lowering \overline{CS} . The Write command (slave address with R/W bit cleared) is then clocked into the device. The opcode is followed by an address and at least one data byte.

1.3.3.2 SPI Read Operation

The SPI Read operation is started by lowering \overline{CS} . The SPI read command (slave address with R/W bit set) is then clocked into the device. The opcode is followed by an address, with at least one data byte being clocked out of the device.

MCP23008 I²C™ DEVICE PROTOCOL FIGURE 1-1: s - START - RESTART DIN DIN S OP **ADDR** P - STOP w - Write SR OP R **D**OUT **D**OUT R - Read -SR OP W DIN DIN - Device opcode OP **ADDR** - Device address P - Data out from MCP23008 **D**OUT DIN - Data into MCP23008 Р S OP R **DOUT D**OUT SR OP R **D**OUT **DOUT** DIN SR w OP **ADDR** DIN ► P Byte and Sequential Write S OP **ADDR** DIN Ρ Byte DIN Sequential S OP **ADDR** DIN Byte and Sequential Read Byte S R **D**OUT Ρ **OP** OP Sequential S **DOUT** OP W OP R **D**OUT

1.3.3.3 SPI Sequential Write/Read

For sequential operations, instead of deselecting the device by raising $\overline{\text{CS}}$, the master clocks the next byte pointed to by the address pointer.

The sequence ends by the raising of \overline{CS} .

The MCP23S08 address pointer will roll over to address zero after reaching the last register address.

1.4 Hardware Address Decoder

The hardware address pins are used to determine the device address. To address a device, the corresponding address bits in the control byte must match the pin state.

- MCP23008 has address pins A2, A1 and A0.
- · MCP23S08 has address pins A1 and A0.

The pins must be biased externally.

1.4.1 ADDRESSING I²C DEVICES (MCP23008)

The MCP23008 is a slave I²C device that supports 7-bit slave addressing, with the read/write bit filling out the control byte. The slave address contains four fixed bits and three user-defined hardware address bits (pins A2, A1 and A0). Figure 1-2 shows the control byte format.

1.4.2 ADDRESSING SPI DEVICES (MCP23S08)

The MCP23S08 is a slave SPI device. The slave address contains five fixed bits and two user-defined hardware address bits (pins A1 and A0), with the read/ write bit filling out the control byte. Figure 1-3 shows the control byte format.

FIGURE 1-2: I²C™ CONTROL BYTE FORMAT

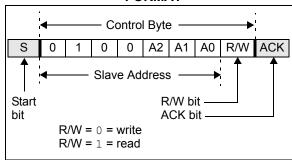


FIGURE 1-3: SPI CONTROL BYTE FORMAT

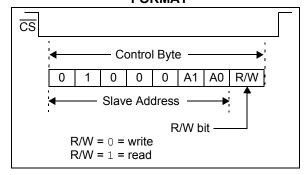


FIGURE 1-4: I²C™ ADDRESSING REGISTERS

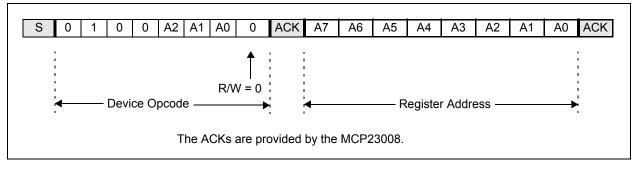
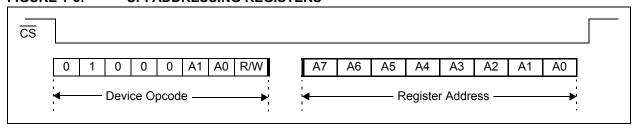


FIGURE 1-5: SPI ADDRESSING REGISTERS



1.5 GPIO Port

The GPIO module contains the data port (GPIO), internal pull up resistors and the Output Latches (OLAT).

Reading the GPIO register reads the value on the port. Reading the OLAT register only reads the OLAT, not the actual value on the port.

Writing to the GPIO register actually causes a write to the OLAT. Writing to the OLAT register forces the associated output drivers to drive to the level in OLAT. Pins configured as inputs turn off the associated output driver and put it in high-impedance.

1.6 Configuration and Control Registers

The Configuration and Control blocks contain the registers as shown in Table 1-3.

TABLE 1-3: CONFIGURATION AND CONTROL REGISTERS

Register Name	Address (hex)	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0	POR/RST value
IODIR	00	107	IO6	IO5	IO4	IO3	IO2	IO1	IO0	1111 1111
IPOL	01	IP7	IP6	IP5	IP4	IP3	IP2	IP1	IP0	0000 0000
GPINTEN	02	GPINT7	GPINT6	GPINT5	GPINT4	GPINT3	GPINT2	GPINT1	GPINT0	0000 0000
DEFVAL	03	DEF7	DEF6	DEF5	DEF4	DEF3	DEF2	DEF1	DEF0	0000 0000
INTCON	04	IOC7	IOC6	IOC5	IOC4	IOC3	IOC2	IOC1	IOC0	0000 0000
IOCON	05	_	_	SREAD	DISSLW	HAEN*	ODR	INTPOL	_	00 000-
GPPU	06	PU7	PU6	PU5	PU4	PU3	PU2	PU1	PU0	0000 0000
INTF	07	INT7	INT6	INT5	INT4	INT3	INT2	INT1	INTO	0000 0000
INTCAP	08	ICP7	ICP6	ICP5	ICP4	ICP3	ICP2	ICP1	ICP0	0000 0000
GPIO	09	GP7	GP6	GP5	GP4	GP3	GP2	GP1	GP0	0000 0000
OLAT	0A	OL7	OL6	OL5	OL4	OL3	OL2	OL1	OL0	0000 0000

^{*} Not used on the MCP23008.

1.6.1 I/O DIRECTION (IODIR) REGISTER

Controls the direction of the data I/O.

When a bit is set, the corresponding pin becomes an input. When a bit is clear, the corresponding pin becomes an output.

REGISTER 1-1: IODIR – I/O DIRECTION REGISTER (ADDR 0x00)

| R/W-1 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| 107 | IO6 | IO5 | 104 | IO3 | IO2 | IO1 | IO0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **IO7:IO0:** These bits control the direction of data I/O <7:0>

1 = Pin is configured as an input.

0 = Pin is configured as an output.

1.6.2 INPUT POLARITY (IPOL) REGISTER

The IPOL register allows the user to configure the polarity on the corresponding GPIO port bits.

If a bit is set, the corresponding GPIO register bit will reflect the inverted value on the pin.

REGISTER 1-2: IPOL – INPUT POLARITY PORT REGISTER (ADDR 0x01)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| IP7 | IP6 | IP5 | IP4 | IP3 | IP2 | IP1 | IP0 |
| bit 7 | | | | | | | bit 0 |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **IP7:IP0:** These bits control the polarity inversion of the input pins <7:0>

1 = GPIO register bit will reflect the opposite logic state of the input pin.

0 = GPIO register bit will reflect the same logic state of the input pin.

1.6.3 INTERRUPT-ON-CHANGE CONTROL (GPINTEN) REGISTER

The GPINTEN register controls the interrupt-onchange feature for each pin.

If a bit is set, the corresponding pin is enabled for interrupt-on-change. The DEFVAL and INTCON registers must also be configured if any pins are enabled for interrupt-on-change.

REGISTER 1-3: GPINTEN – INTERRUPT-ON-CHANGE PINS (ADDR 0x02)

| R/W-0 |
|--------|--------|--------|--------|--------|--------|--------|--------|
| GPINT7 | GPINT6 | GPINT5 | GPINT4 | GPINT3 | GPINT2 | GPINT1 | GPINT0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **GPINT7:GPINT0:** General purpose I/O interrupt-on-change bits <7:0>

1 = Enable GPIO input pin for interrupt-on-change event.

0 = Disable GPIO input pin for interrupt-on-change event.

Refer to INTCON and GPINTEN.

1.6.4 DEFAULT COMPARE (DEFVAL) REGISTER FOR INTERRUPT-ONCHANGE

The default comparison value is configured in the DEFVAL register. If enabled (via GPINTEN and INTCON) to compare against the DEFVAL register, an opposite value on the associated pin will cause an interrupt to occur.

REGISTER 1-4: DEFVAL - DEFAULT VALUE REGISTER (ADDR 0x03)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| DEF7 | DEF6 | DEF5 | DEF4 | DEF3 | DEF2 | DEF1 | DEF0 |
| bit 7 | | | | | | | bit 0 |

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **DEF7:DEF0:** These bits set the compare value for pins configured for interrupt-on-change from defaults <7:0>. Refer to INTCON.

If the associated pin level is the opposite from the register bit, an interrupt occurs.

Refer to INTCON and GPINTEN.

1.6.5 INTERRUPT CONTROL (INTCON) REGISTER

The INTCON register controls how the associated pin value is compared for the interrupt-on-change feature. If a bit is set, the corresponding I/O pin is compared against the associated bit in the DEFVAL register. If a bit value is clear, the corresponding I/O pin is compared against the previous value.

REGISTER 1-5: INTCON – INTERRUPT-ON-CHANGE CONTROL REGISTER (ADDR 0x04)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| IOC7 | IOC6 | IOC5 | IOC4 | IOC3 | IOC2 | IOC1 | IOC0 |
| bit 7 | | | | | | | bit 0 |

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **IOC7:IOC0:** These bits control how the associated pin value is compared for interrupt-on-change <7:0>

1 = Controls how the associated pin value is compared for interrupt-on-change.

0 = Pin value is compared against the previous pin value.

Refer to INTCON and GPINTEN.

1.6.6 **CONFIGURATION (IOCON) REGISTER**

The IOCON register contains several bits configuring the device:

- · The Sequential Operation (SEQOP) controls the incrementing function of the address pointer. If the address pointer is disabled, the address pointer does not automatically increment after each byte is clocked during a serial transfer. This feature is useful when it is desired to continuously poll (read) or modify (write) a register.
- The Slew Rate (DISSLW) bit controls the slew rate function on the SDA pin. If enabled, the SDA slew rate will be controlled when driving from a high to a low.

- · The Hardware Address Enable (HAEN) control bit enables/disables the hardware address pins (A1, A0) on the MCP23S08. This bit is not used on the MCP23008. The address pins are always enabled on the MCP23008.
- The Open-Drain (ODR) control bit enables/ disables the INT pin for open-drain configuration.
- The Interrupt Polarity (INTPOL) control bit sets the polarity of the INT pin. This bit is functional only when the ODR bit is cleared, configuring the INT pin as active push-pull.

REGISTER 1-6: IOCON – I/O EXPANDER CONFIGURATION REGISTER (ADDR 0x05)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
_	_	SEQOP	DISSLW	HAEN	ODR	INTPOL	_
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	l as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 Unimplemented: Read as '0'.

bit 5 SEQOP: Sequential Operation mode bit.

1 = Sequential operation disabled, address pointer does not increment.

0 = Sequential operation enabled, address pointer increments.

DISSLW: Slew Rate control bit for SDA output. bit 4

> 1 = Slew rate disabled. 0 = Slew rate enabled.

bit 3 HAEN: Hardware Address Enable bit (MCP23S08 only).

Address pins are always enabled on MCP23008.

1 = Enables the MCP23S08 address pins.

0 = Disables the MCP23S08 address pins.

ODR: This bit configures the INT pin as an open-drain output. bit 2

1 = Open-drain output (overrides the INTPOL bit).

0 = Active driver output (INTPOL bit sets the polarity).

INTPOL: This bit sets the polarity of the INT output pin.

1 = Active-high.

0 = Active-low.

bit 1

bit 0 Unimplemented: Read as '0'.

1.6.7 PULL-UP RESISTOR CONFIGURATION (GPPU) REGISTER

The GPPU register controls the pull-up resistors for the port pins. If a bit is set and the corresponding pin is configured as an input, the corresponding port pin is internally pulled up with a 100 k Ω resistor.

REGISTER 1-7: GPPU – GPIO PULL-UP RESISTOR REGISTER (ADDR 0x06)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| PU7 | PU6 | PU5 | PU4 | PU3 | PU2 | PU1 | PU0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **PU7:PU0:** These bits control the weak pull-up resistors on each pin (when configured as an input) <7:0>.

1 = Pull-up enabled.

0 = Pull-up disabled.

1.6.8 INTERRUPT FLAG (INTF) REGISTER

The INTF register reflects the interrupt condition on the port pins of any pin that is enabled for interrupts via the GPINTEN register. A 'set' bit indicates that the associated pin caused the interrupt.

This register is 'read-only'. Writes to this register will be ignored.

Note: INTF will always reflect the pin(s) that have an interrupt condition. For example, one pin causes an interrupt to occur and is captured in INTCAP and INF. If before clearing the interrupt another pin changes, which would normally cause an interrupt, it will be reflected in INTF, but not INTCAP.

REGISTER 1-8: INTF – INTERRUPT FLAG REGISTER (ADDR 0x07)

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
INT7	INT6	INT5	INT4	INT3	INT2	INT1	INT0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **INT7:INT0:** These bits reflect the interrupt condition on the port. Will reflect the change only if interrupts are enabled (GPINTEN) <7:0>.

1 = Pin caused interrupt.

0 = Interrupt not pending.

1.6.9 INTERRUPT CAPTURE (INTCAP) REGISTER

The INTCAP register captures the GPIO port value at the time the interrupt occurred. The register is 'read-only' and is updated only when an interrupt occurs. The register will remain unchanged until the interrupt is cleared via a read of INTCAP or GPIO.

REGISTER 1-9: INTCAP – INTERRUPT CAPTURED VALUE FOR PORT REGISTER (ADDR 0x08)

R-x	R-x	R-x	R-x	R-x	R-x	R-x	R-x
ICP7	ICP6	ICP5	ICP4	ICP3	ICP2	ICP1	ICP0
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **ICP7:ICP0:** These bits reflect the logic level on the port pins at the time of interrupt due to pin change <7:0>

1 = Logic-high.

0 = Logic-low.

1.6.10 PORT (GPIO) REGISTER

The GPIO register reflects the value on the port. Reading from this register reads the port. Writing to this register modifies the Output Latch (OLAT) register.

REGISTER 1-10: GPIO – GENERAL PURPOSE I/O PORT REGISTER (ADDR 0x09)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| GP7 | GP6 | GP5 | GP4 | GP3 | GP2 | GP1 | GP0 |
| bit 7 | | | | | | | bit 0 |

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7-0 **GP7:GP0:** These bits reflect the logic level on the pins <7:0>

1 = Logic-high.

0 = Logic-low.

1.6.11 OUTPUT LATCH REGISTER (OLAT)

The OLAT register provides access to the output latches. A read from this register results in a read of the OLAT and not the port itself. A write to this register modifies the output latches that modify the pins configured as outputs.

REGISTER 1-11: OLAT – OUTPUT LATCH REGISTER 0 (ADDR 0x0A)

| R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| OL7 | OL6 | OL5 | OL4 | OL3 | OL2 | OL1 | OL0 |
| bit 7 | | | | | | | bit 0 |

Legend:R = Readable bitW = Writable bitU = Unimplemented bit, read as '0'-n = Value at POR'1' = Bit is set'0' = Bit is clearedx = Bit is unknown

bit 7-0 **OL7:OL0:** These bits reflect the logic level on the output latch <7:0>

1 = Logic-high.

0 = Logic-low.

1.7 Interrupt Logic

The interrupt output pin will activate if an internal interrupt occurs. The interrupt block is configured by the following registers:

- · GPINTEN enables the individual inputs
- DEFVAL holds the values that are compared against the associated input port values
- INTCON controls if the input values are compared against DEFVAL or the previous values on the port
- IOCON (ODR and INPOL) configures the INT pin as push-pull, open-drain and active-level

Only pins configured as inputs can cause interrupts. Pins configured as outputs have no affect on INT.

Interrupt activity on the port will cause the port value to be captured and copied into INTCAP. The interrupt will remain active until the INTCAP or GPIO register is read. Writing to these registers will not affect the interrupt.

The first interrupt event will cause the port contents to be copied into the INTCAP register. Subsequent interrupt conditions on the port will not cause an interrupt to occur as long as the interrupt is not cleared by a read of INTCAP or GPIO.

1.7.1 INTERRUPT CONDITIONS

There are two possible configurations to cause interrupts (configured via INTCON):

- Pins configured for interrupt-on-pin-change will cause an interrupt to occur if a pin changes to the opposite state. The default state is reset after an interrupt occurs. For example, an interrupt occurs by an input changing from 1 to 0. The new initial state for the pin is a logic 0.
- Pins configured for interrupt-on-change from register value will cause an interrupt to occur if the corresponding input pin differs from the register bit. The interrupt condition will remain as long as the condition exists, regardless if the INTAP or GPIO is read.

See Figure 1-6 and Figure 1-7 for more information on interrupt operations.

FIGURE 1-6: INTERRUPT-ON-PIN-CHANGE

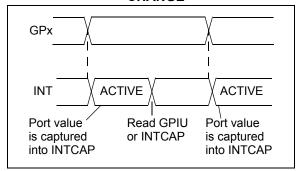
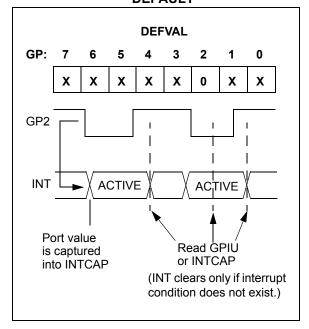


FIGURE 1-7: INTERRUPT-ON-CHANGE FROM REGISTER DEFAULT



NOTES:

2.0 **ELECTRICAL CHARACTERISTICS**

Absolute Maximum Ratings †

Ambient	temperature under bias	40°C to +125°C
Storage	temperature	65°C to +150°C
Voltage	on VDD with respect to Vss	-0.3V to +5.5V
Voltage	on all other pins with respect to Vss (except VDD)	0.6V to (VDD + 0.6V)
Total po	wer dissipation (Note)	700 mW
Maximu	m current out of Vss pin	150 mA
Maximu	m current into VDD pin	125 mA
Input cla	mp current, lik (VI < 0 or VI > VDD)	±20 mA
Output o	clamp current, loк (Vo < 0 or Vo > VDD)	±20 mA
Maximu	m output current sunk by any output pin	25 mA
Maximu	m output current sourced by any output pin	25 mA
Note:	Power dissipation is calculated as follows:	

PDIS = VDD x {IDD - \sum IOH} + \sum {(VDD-VOH) x IOH} + \sum (VOL x IOL)

[†] NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

2.1 DC Characteristics

DC Cha	racteristics	Operating Conditions (unless otherwise indicated): $1.8V \le VDD \le 5.5V$ at $-40^{\circ}C \le TA \le +85^{\circ}C$ (I-Temp) $4.5V \le VDD \le 5.5V$ at $-40^{\circ}C \le TA \le +125^{\circ}C$ (E-Temp) (Note 1)								
Param No.	Characteristic	Sym	Min	Тур	Max	Units	Conditions			
D001	Supply Voltage	VDD	1.8	_	5.5	V				
D002	VDD Start Voltage to Ensure Power-on Reset	VPOR	_	Vss	_	V				
D003	VDD Rise Rate to Ensure Power-on Reset	SVDD	0.05	_	_	V/ms	Design guidance only. Not tested.			
D004	Supply Current	IDD	_	_	1	mA	SCL/SCK = 1 MHz			
D005	Standby current	IDDS	_	_	1	μA				
			_	_	2	μA	4.5V - 5.5V @ +125°C (Note 1)			
	Input Low-Voltage	1					1			
D030	A0, A1 (TTL buffer)	VIL	Vss	_	0.15 VDD	V				
D031 CS, GPIO, SCL/SCK SDA, A2, RESET (Schmitt Trigger)			Vss	_	0.2 VDD	V				
	Input High-Voltage	-								
D040	A0, A1 (TTL buffer)	VIH	0.25 VDD + 0.8	_	VDD	V				
D041	CS, GPIO, SCL/SCK, SDA, A2, RESET (Schmitt Trigger)		0.8 VDD	_	VDD	V	For entire VDD range.			
	Input Leakage Curren	t			•					
D060	I/O port pins	lıL	_	_	±1	μA	$Vss \le Vpin \le Vdd$			
	Output Leakage Curre	ent					1			
D065	I/O port pins	ILO	_	_	±1	μA	$Vss \le Vpin \le Vdd$			
D070	GPIO weak pull-up current	lpu	40	75	115	μA	VDD = 5V, GP Pins = VSS - 40° C \leq TA \leq +85 $^{\circ}$ C			
	Output Low-Voltage	-								
D080	GPIO	Vol	_	_	0.6	V	IOL = 8.5 mA, VDD = 4.5V			
	INT		_		0.6	V	IOL = 1.6 mA, VDD = 4.5V			
	SO, SDA		_	_	0.6	V	IOL = 3.0 mA, VDD = 1.8V			
	SDA		_	_	0.8	V	IOL = 3.0 mA, VDD = 4.5V			
	Output High-Voltage	1	1				1			
D090	GPIO, INT, SO	Voн	VDD - 0.7	_	_	V	IOH = -3.0 mA, VDD = 4.5V			
			VDD - 0.7	_			IOH = -400 μA, VDD = 1.8V			
	Capacitive Loading S	pecs on (Output Pins		1 1		I			
D101	GPIO, SO, INT	Сю		_	50	pF				
	i .	1	1		1		1			

Note 1: This parameter is characterized, not 100% tested.

FIGURE 2-1: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS

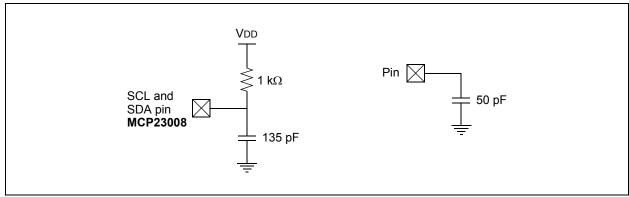


FIGURE 2-2: RESET AND DEVICE RESET TIMER TIMING

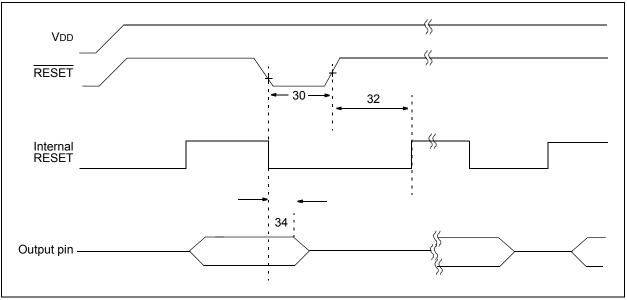


TABLE 2-1: DEVICE RESET SPECIFICATIONS

AC Char	racteristics	Operating Conditions (unless otherwise indicated): $1.8V \le VDD \le 5.5V$ at $-40^{\circ}C \le TA \le +85^{\circ}C$ (I-Temp) $4.5V \le VDD \le 5.5V$ at $-40^{\circ}C \le TA \le +125^{\circ}C$ (E-Temp) (Note 1)						
Param Characteristic		Sym	Min	Typ ⁽¹⁾	Max	Units	Conditions	
30	RESET Pulse Width (Low)	TRSTL	1			μs		
32	Device Active After RESET high	THLD		0		μs	VDD = 5.0V	
34	Output High-Impedance From RESET Low	Tıoz			1	μs		

Note 1: This parameter is characterized, not 100% tested.

FIGURE 2-3: I²C™ BUS START/STOP BITS TIMING

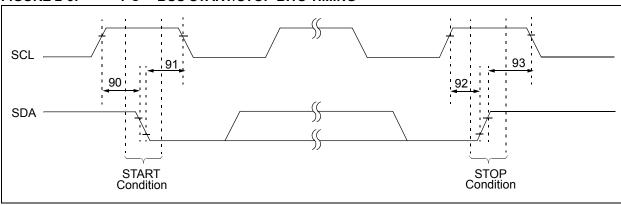


FIGURE 2-4: I²C™ BUS DATA TIMING

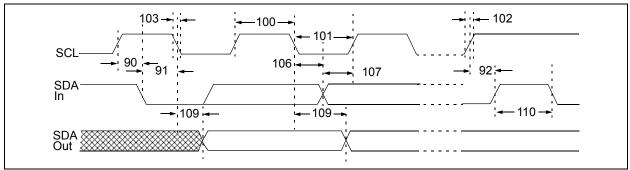


TABLE 2-2: I²C™ BUS DATA REQUIREMENTS

I ² C™ A	C Characteristics	Operating Conditions (unless otherwise indicated): $1.8V \le VDD \le 5.5V \text{ at } -40^{\circ}C \le TA \le +85^{\circ}C \text{ (I-Temp)} $ $4.5V \le VDD \le 5.5V \text{ at } -40^{\circ}C \le TA \le +125^{\circ}C \text{ (E-Temp)} \text{ (Note 1)} $ RPU (SCL, SDA) = 1 k Ω , CL (SCL, SDA) = 135 pF							
Param No.	Characteristic	Sym	Min	Тур	Max	Units	Conditions		
100	Clock High Time:	THIGH							
	100 kHz mode		4.0		_	μs	1.8V – 5.5V (I-Temp)		
	400 kHz mode		0.6		_	μs	2.7V – 5.5V (I-Temp)		
	1.7 MHz mode		0.12	_	_	μs	4.5V – 5.5V (E-Temp)		
101	Clock Low Time:	TLOW		•	•	•			
	100 kHz mode		4.7	_	_	μs	1.8V – 5.5V (I-Temp)		
	400 kHz mode		1.3	_	_	μs	2.7V – 5.5V (I-Temp)		
	1.7 MHz mode		0.32	_	_	μs	4.5V – 5.5V (E-Temp)		
102	SDA and SCL Rise Time:	Tr			•	•			
	100 kHz mode	(Note 1)	_	_	1000	ns	1.8V – 5.5V (I-Temp)		
	400 kHz mode		20 + 0.1 CB ⁽²⁾	_	300	ns	2.7V – 5.5V (I-Temp)		
	1.7 MHz mode		20		160	ns	4.5V – 5.5V (E-Temp)		
103	SDA and SCL Fall Time:	TF		•	•	•			
	100 kHz mode	(Note 1)	_	_	300	ns	1.8V – 5.5V (I-Temp)		
	400 kHz mode		20 + 0.1 CB ⁽²⁾	_	300	ns	2.7V – 5.5V (I-Temp)		
	1.7 MHz mode		20	_	80	ns	4.5V – 5.5V (E-Temp)		
90	START Condition Setup Time:	Tsu:sta							
	100 kHz mode		4.7	_	_	μs	1.8V – 5.5V (I-Temp)		
	400 kHz mode		0.6	_	_	μs	2.7V – 5.5V (I-Temp)		
	1.7 MHz mode		0.16	_	_	μs	4.5V – 5.5V (E-Temp)		
91	START Condition Hold Time:	THD:STA							
	100 kHz mode		4.0	_	_	μs	1.8V – 5.5V (I-Temp)		
	400 kHz mode		0.6	_	_	μs	2.7V – 5.5V (I-Temp)		
	1.7 MHz mode		0.16	_	_	μs	4.5V – 5.5V (E-Temp)		
106	Data Input Hold Time:	THD:DAT							
	100 kHz mode		0	_	3.45	μs	1.8V – 5.5V (I-Temp)		
	400 kHz mode		0		0.9	μs	2.7V – 5.5V (I-Temp)		
	1.7 MHz mode		0		0.15	μs	4.5V – 5.5V (E-Temp)		
107	Data Input Setup Time:	Tsu:dat							
	100 kHz mode		250		_	ns	1.8V – 5.5V (I-Temp)		
	400 kHz mode		100		_	ns	2.7V – 5.5V (I-Temp)		
	1.7 MHz mode		0.01	_	_	μs	4.5V – 5.5V (E-Temp)		
92	STOP Condition Setup Time:	Tsu:sto							
	100 kHz mode		4.0	_	_	μs	1.8V – 5.5V (I-Temp)		
	400 kHz mode		0.6	_	_	μs	2.7V – 5.5V (I-Temp)		
	1.7 MHz mode		0.16	_	_	μs	4.5V - 5.5V (E-Temp)		

Note 1: This parameter is characterized, not 100% tested.

2: CB is specified to be from 10 to 400 pF.

TABLE 2-2: I²C™ BUS DATA REQUIREMENTS (CONTINUED)

I ² C™ A	C Characteristics	Operating Conditions (unless otherwise indicated): 1.8V \leq VDD \leq 5.5V at -40°C \leq TA \leq +85°C (I-Temp) 4.5V \leq VDD \leq 5.5V at -40°C \leq TA \leq +125°C (E-Temp) (Note 1) RPU (SCL, SDA) = 1 kΩ, CL (SCL, SDA) = 135 pF						
Param No.	Characteristic	Sym	Min	Тур	Max	Units	Conditions	
109	Output Valid From Clock:	TAA						
	100 kHz mode		_	_	3.45	μs	1.8V – 5.5V (I-Temp)	
	400 kHz mode		_	_	0.9	μs	2.7V – 5.5V (I-Temp)	
	1.7 MHz mode		_	_	0.18	μs	4.5V – 5.5V (E-Temp)	
110	Bus Free Time:	TBUF						
	100 kHz mode		4.7	_	_	μs	1.8V – 5.5V (I-Temp)	
	400 kHz mode		1.3	_	_	μs	2.7V – 5.5V (I-Temp)	
	1.7 MHz mode		N/A	_	N/A	μs	4.5V – 5.5V (E-Temp)	
	Bus Capacitive Loading:	Св						
	100 kHz and 400 kHz		_	I —	400	pF	(Note 1)	
	1.7 MHz		_	_	100	pF	(Note 1)	
	Input Filter Spike Suppression: (SDA and SCL)	TSP						
	100 kHz and 400 kHz				50	ns		
	1.7 MHz		_	_	10	ns	Spike suppression off	

Note 1: This parameter is characterized, not 100% tested.

2: CB is specified to be from 10 to 400 pF.

FIGURE 2-5: SPI INPUT TIMING

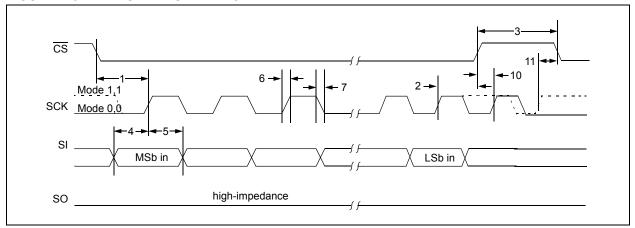


FIGURE 2-6: SPI OUTPUT TIMING

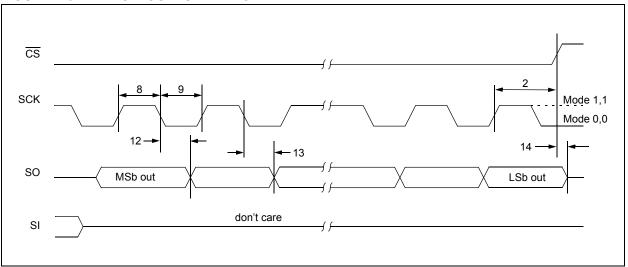


TABLE 2-3: SPI INTERFACE AC CHARACTERISTICS

SPI Interface AC Characteristics		Operating Conditions (unless otherwise indicated): $1.8V \le VDD \le 5.5V \text{ at } -40^{\circ}C \le TA \le +85^{\circ}C \text{ (I-Temp)} \\ 4.5V \le VDD \le 5.5V \text{ at } -40^{\circ}C \le TA \le +125^{\circ}C \text{ (E-Temp)} \text{ (Note 1)}$						
Param No.	Characteristic	Sym	Min	Тур	Max	Units	Conditions	
	Clock Frequency	FCLK	_		5	MHz	1.8V – 5.5V (I-Temp)	
			_		10	MHz	2.7V - 5.5V (I-Temp)	
			_	_	10	MHz	4.5V – 5.5V (E-Temp)	
1	CS Setup Time	Tcss	50	1	_	ns		
2	CS Hold Time	Тсѕн	100	1	_	ns	1.8V – 5.5V (I-Temp)	
			50	_	_	ns	2.7V – 5.5V (I-Temp)	
			50	1		ns	4.5V – 5.5V (E-Temp)	
3	CS Disable Time	TCSD	100	1		ns	1.8V – 5.5V (I-Temp)	
			50	1		ns	2.7V – 5.5V (I-Temp)	
			50	1		ns	4.5V – 5.5V (E-Temp)	
4	Data Setup Time	Tsu	20	_	_	ns	1.8V – 5.5V (I-Temp)	
			10	1		ns	2.7V – 5.5V (I-Temp)	
			10	1		ns	4.5V – 5.5V (E-Temp)	
5	Data Hold Time	THD	20	1	_	ns	1.8V – 5.5V (I-Temp)	
			10	_	_	ns	2.7V – 5.5V (I-Temp)	
			10	1	_	ns	4.5V - 5.5V (E-Temp)	
6	CLK Rise Time	Tr	_	_	2	μs	Note 1	
7	CLK Fall Time	TF	_	_	2	μs	Note 1	
8	Clock High Time	Тні	90		_	ns	1.8V – 5.5V (I-Temp)	
			45		_	ns	2.7V – 5.5V (I-Temp)	
			45	1	_	ns	4.5V – 5.5V (E-Temp)	

Note 1: This parameter is characterized, not 100% tested.

2: Tv = 90 ns (max) when address pointer rolls over from address 0x0A to 0x00.

TABLE 2-3: SPI INTERFACE AC CHARACTERISTICS (CONTINUED)

SPI Interface AC Characteristics		Operating Conditions (unless otherwise indicated): $1.8V \le VDD \le 5.5V$ at $-40^{\circ}C \le TA \le +85^{\circ}C$ (I-Temp) $4.5V \le VDD \le 5.5V$ at $-40^{\circ}C \le TA \le +125^{\circ}C$ (E-Temp) (Note 1)						
Param No.	Characteristic	Sym	Min Typ Max Units Conditions				Conditions	
9	Clock Low Time	TLO	90		_	ns	1.8V – 5.5V (I-Temp)	
			45	1	_	ns	2.7V - 5.5V (I-Temp)	
			45	I	_	ns	4.5V – 5.5V (E-Temp)	
10	Clock Delay Time	TCLD	50	I	_	ns		
11	Clock Enable Time	TCLE	50	1	_	ns		
12 ⁽²⁾	Output Valid from Clock Low	Tv	_	1	90	ns	1.8V – 5.5V (I-Temp)	
			_	I	45	ns	2.7V – 5.5V (I-Temp)	
			_		45	ns	4.5V – 5.5V (E-Temp)	
13	Output Hold Time	Тно	0		_	ns		
14	Output Disable Time	Tois	_		100	ns		

Note 1: This parameter is characterized, not 100% tested.

2: Tv = 90 ns (max) when address pointer rolls over from address 0x0A to 0x00.

FIGURE 2-7: GPIO AND INT TIMING

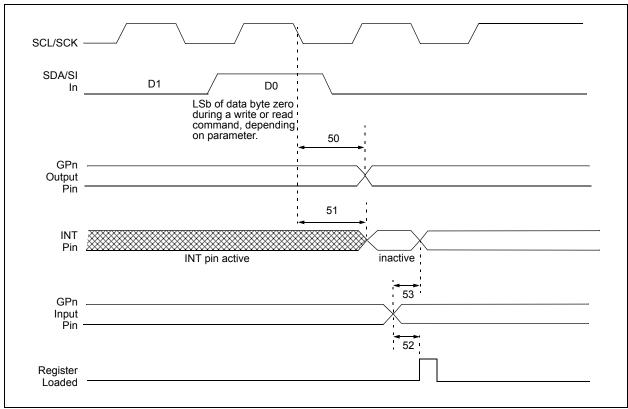


TABLE 2-4: GP AND INT PINS

AC Characteristics		Operating Conditions (unless otherwise indicated): $1.8V \le VDD \le 5.5V$ at $-40^{\circ}C \le TA \le +85^{\circ}C$ (I-Temp) $4.5V \le VDD \le 5.5V$ at $-40^{\circ}C \le TA \le +125^{\circ}C$ (E-Temp) (Note 1)					
Param No.	Characteristic	Sym	Min	Тур	Max	Units	Conditions
50	Serial data to output valid	Tgpov		_	500	ns	
51	Interrupt pin disable time	TINTD	_	_	600	ns	
52	GP input change to register valid	TGPIV	_	_	450	ns	
53	IOC event to INT active	TGPINT	_	_	600	ns	
	Glitch Filter on GP Pins	TGLITCH		_	150	ns	

Note 1: This parameter is characterized, not 100% tested

NOTES:

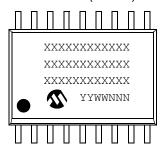
3.0 PACKAGING INFORMATION

3.1 Package Marking Information

18-Lead PDIP (300 mil)



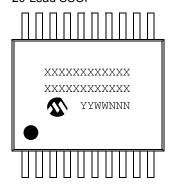
18-Lead SOIC (300 mil)



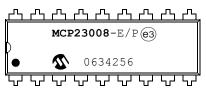
20-Lead QFN



20-Lead SSOP



Example:



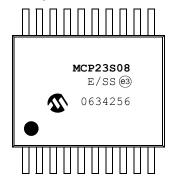
Example:



Example



Example:



Legend: XX...X Customer-specific information

Y Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')

NNN Alphanumeric traceability code

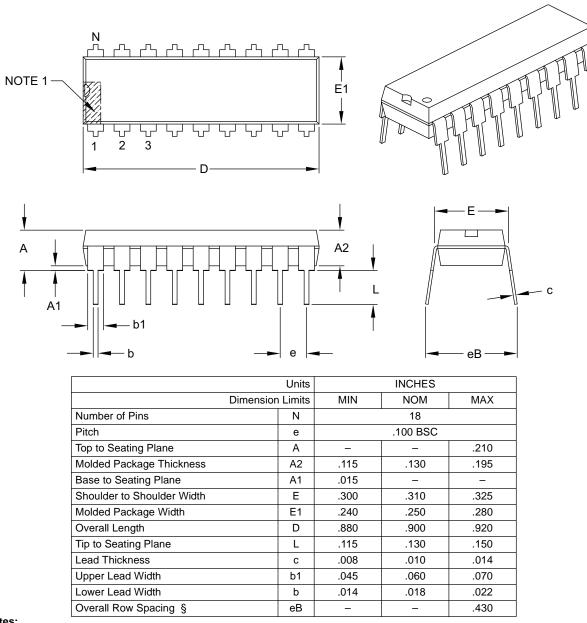
e3 Pb-free JEDEC designator for Matte Tin (Sn)

This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

18-Lead Plastic Dual In-Line (P) - 300 mil Body [PDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Notes:

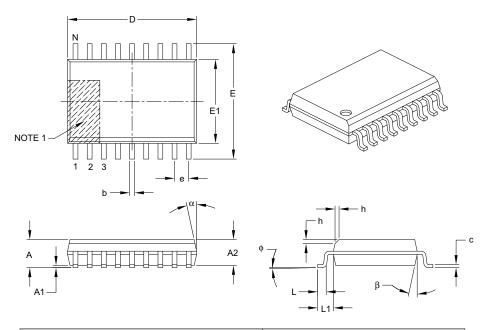
- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-007B

18-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS			
	Dimension Limits	MIN	NOM	MAX	
Number of Pins	N		18		
Pitch	е		1.27 BSC		
Overall Height	A	_	_	2.65	
Molded Package Thickness	A2	2.05	_	_	
Standoff §	A1	0.10	_	0.30	
Overall Width	E	10.30 BSC			
Molded Package Width E1			7.50 BSC		
Overall Length	D	11.55 BSC			
Chamfer (optional)	h	0.25	_	0.75	
Foot Length	L	0.40	_	1.27	
Footprint L1		1.40 REF			
Foot Angle	ф	0°	_	8°	
Lead Thickness	С	0.20 – 0.33			
Lead Width	b	0.31	_	0.51	
Mold Draft Angle Top	α	5°	_	15°	
Mold Draft Angle Bottom	β	5°	_	15°	

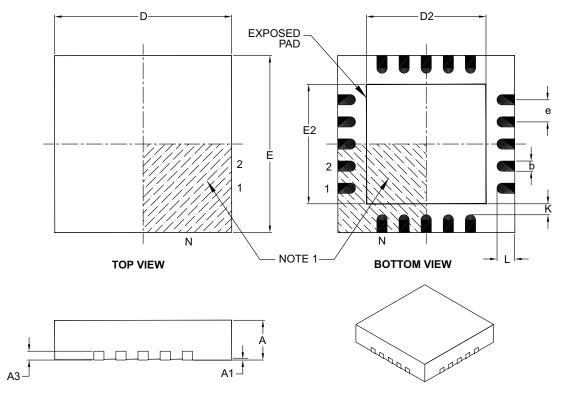
Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-051B

20-Lead Plastic Quad Flat, No Lead Package (ML) – 4x4x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS			
Dimensi	on Limits	MIN	NOM	MAX	
Number of Pins	umber of Pins N		20		
Pitch	е		0.50 BSC		
Overall Height	Α	0.80	0.90	1.00	
Standoff	A1	0.00	0.02	0.05	
Contact Thickness	A3	0.20 REF			
Overall Width	E	4.00 BSC			
Exposed Pad Width	E2	2.60	2.70	2.80	
Overall Length D		4.00 BSC			
Exposed Pad Length	D2	2.60	2.70	2.80	
Contact Width	b	0.18	0.25	0.30	
Contact Length	L	0.30	0.40	0.50	
Contact-to-Exposed Pad	K	0.20	_	_	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package is saw singulated.
- 3. Dimensioning and tolerancing per ASME Y14.5M.

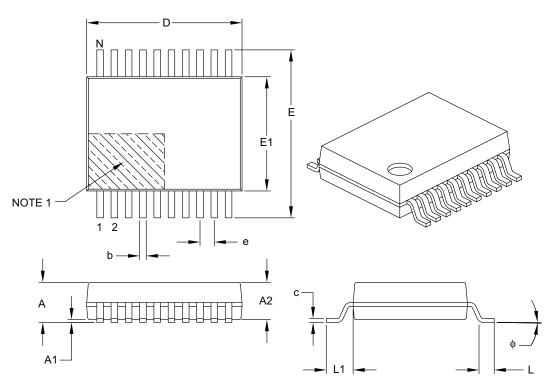
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-126B

20-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	MILLIMETERS			
Dimensi	on Limits	MIN	NOM	MAX	
Number of Pins	Number of Pins N		20		
Pitch	е	0.65 BSC			
Overall Height	Α	_	_	2.00	
Molded Package Thickness	A2	1.65	1.75	1.85	
Standoff	A1	0.05	_	_	
Overall Width	E	7.40	7.80	8.20	
Molded Package Width	E1	5.00	5.30	5.60	
Overall Length	D	6.90	7.20	7.50	
Foot Length	L	0.55	0.75	0.95	
Footprint		1.25 REF			
Lead Thickness	С	0.09	_	0.25	
Foot Angle	ф	0°	4°	8°	
Lead Width	b	0.22	_	0.38	

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
- 3. Dimensioning and tolerancing per ASME Y14.5M.
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-072B

NOTES:

APPENDIX A: REVISION HISTORY

Revision E (August 2007)

 Section 3.0 "Packaging Information": Updated package outline drawings.

Revision D (February 2007)

- 1. Changed Byte and Sequential Read in Figure 1-1 from "R" to "W".
- 2. Table 2-4, Param No. 51 and 53: Changed from 450 to 600 and 500 to 600, respecively.
- 3. Added disclaimer to package outline drawings.
- 4. Updated package outline drawings.

Revision C (October 2006)

- 1. Added 20-pin QFN package information throughout document.
- 2. Added disclaimer to package outline drawings.

Revision B (February 2005)

The following is the list of modifications:

- Section 1.6 "Configuration and Control Registers". Added Hardware Address Enable (HAEN) bit to Table 1-3.
- 2. **Section 1.6.6 "Configuration (IOCON) Register"**. Added Hardware Address Enable (HAEN) bit to Register 1-6.

Revision A (December 2004)

· Original Release of this Document.

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	- <u>X</u> / <u>XX</u>	Examples:				
Device	Temperature Package	a) MCP23008-E/P: Extended Temp., 18LD PDIP package.				
	Range	b) MCP23008-E/SO: Extended Temp., 18LD SOIC package.				
Device	MCP23008: 8-Bit I/O Expander w/ I ² C ™ Interface MCP23008T: 8-Bit I/O Expander w/ I ² C Interface (Tape and Reel)	c) MCP23008T-E/SO: Tape and Reel, Extended Temp., 18LD SOIC package.				
	MCP23S08: 8-Bit I/O Expander w/ SPI Interface MCP23S08T: 8-Bit I/O Expander w/ SPI Interface	d) MCP23008-E/SS: Extended Temp., 20LD SSOP package.				
	(Tape and Reel)	e) MCP23008T-E/SS: Tape and Reel, Extended Temp., 20LD SSOP package.				
Temperature Range	E = -40°C to +125°C (Extended) *	f) MCP23008-E/ML: Extended Temp., 20LD QFN package.				
	* While these devices are only offered in the "E" temperature range, the device will operate at different					
	voltages and temperatures as identified in the Section 2.0 "Electrical Characteristics".	a) MCP23S08-E/P: Extended Temp., 18LD PDIP package.				
Package	ML = Plastic Quad Flat, No Lead Package	b) MCP23S08-E/SO: Extended Temp., 18LD SOIC package.				
	4x4x0.9 mm Body (QFN), 20-Lead P = Plastic DIP (300 mil Body), 18-Lead SO = Plastic SOIC (300 mil Body), 18-Lead	c) MCP23S08T-E/SO: Tape and Reel, Extended Temp., 18LD SOIC package.				
	SS = SSOP, (209 mil Body, 5.30 mm), 20-Lead	d) MCP23S08-E/SS: Extended Temp., 20LD SSOP package.				
		e) MCP23S08T-E/SS: Tape and Reel, Extended Temp., 20LD SSOP package.				
		f) MCP23S08T-E/MF: Tape and Reel, Extended Temp., 20LD QFN package.				

NOTES:

Note the following details of the code protection feature on Microchip devices:

- · Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our
 knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data
 Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

Trademarks

The Microchip name and logo, the Microchip logo, Accuron, dsPIC, Keeloq, Keeloq logo, microID, MPLAB, PIC, PICmicro, PICSTART, PRO MATE, rfPIC and SmartShunt are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

AmpLab, FilterLab, Linear Active Thermistor, Migratable Memory, MXDEV, MXLAB, SEEVAL, SmartSensor and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Analog-for-the-Digital Age, Application Maestro, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, ECAN, ECONOMONITOR, FanSense, FlexROM, fuzzyLAB, In-Circuit Serial Programming, ICSP, ICEPIC, Mindi, MiWi, MPASM, MPLAB Certified logo, MPLIB, MPLINK, PICkit, PICDEM, PICDEM.net, PICLAB, PICtail, PowerCal, PowerInfo, PowerMate, PowerTool, REAL ICE, rfLAB, Select Mode, Smart Serial, SmartTel, Total Endurance, UNI/O, WiperLock and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

All other trademarks mentioned herein are property of their respective companies.

© 2007, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

Printed on recycled paper.

QUALITY MANAGEMENT SYSTEM

CERTIFIED BY DNV

ISO/TS 16949:2002

Microchip received ISO/TS-16949:2002 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and manufacture of development systems is ISO 9001:2000 certified.



WORLDWIDE SALES AND SERVICE

AMERICAS

Corporate Office

2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277

Technical Support:

http://support.microchip.com

Web Address: www.microchip.com

Atlanta

Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Roston

Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL

Tel: 630-285-0071 Fax: 630-285-0075

Dallas

Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit

Farmington Hills, MI Tel: 248-538-2250 Fax: 248-538-2260

Kokomo

Kokomo, IN Tel: 765-864-8360 Fax: 765-864-8387

Los Angeles

Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

Santa Clara

Santa Clara, CA Tel: 408-961-6444 Fax: 408-961-6445

Toronto

Mississauga, Ontario,

Canada

Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Asia Pacific Office

Suites 3707-14, 37th Floor Tower 6, The Gateway Harbour City, Kowloon Hong Kong

Tel: 852-2401-1200 Fax: 852-2401-3431

Australia - Sydney

Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing

Tel: 86-10-8528-2100 Fax: 86-10-8528-2104

China - Chengdu Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

China - Fuzhou

Tel: 86-591-8750-3506 Fax: 86-591-8750-3521

China - Hong Kong SAR Tel: 852-2401-1200

Fax: 852-2401-3431

China - Qingdao Tel: 86-532-8502-7355

Fax: 86-532-8502-7205

China - Shanghai

Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

China - Shenyang

Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

China - Shenzhen

Tel: 86-755-8203-2660 Fax: 86-755-8203-1760

China - Shunde

Tel: 86-757-2839-5507 Fax: 86-757-2839-5571

China - Wuhan

Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

China - Xian

Tel: 86-29-8833-7252 Fax: 86-29-8833-7256

ASIA/PACIFIC

India - Bangalore

Tel: 91-80-4182-8400 Fax: 91-80-4182-8422

India - New Delhi

Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune

Tel: 91-20-2566-1512 Fax: 91-20-2566-1513

Japan - Yokohama

Tel: 81-45-471- 6166 Fax: 81-45-471-6122

Korea - Daegu

Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul

Tel: 82-2-554-7200 Fax: 82-2-558-5932 or

82-2-558-5934

Malaysia - Penang Tel: 60-4-646-8870 Fax: 60-4-646-5086

Philippines - Manila

Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore

Tel: 65-6334-8870 Fax: 65-6334-8850 Taiwan - Hsin Chu

Tel: 886-3-572-9526

Fax: 886-3-572-6459

Taiwan - Kaohsiung Tel: 886-7-536-4818

Fax: 886-7-536-4803

Taiwan - Taipei

Tel: 886-2-2500-6610 Fax: 886-2-2508-0102

Thailand - Bangkok Tel: 66-2-694-1351

Fax: 66-2-694-1350

EUROPE

Austria - Wels

Tel: 43-7242-2244-39 Fax: 43-7242-2244-393

Denmark - Copenhagen

Tel: 45-4450-2828 Fax: 45-4485-2829

France - Paris

Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany - Munich

Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Italy - Milan

Tel: 39-0331-742611 Fax: 39-0331-466781

Netherlands - Drunen

Tel: 31-416-690399 Fax: 31-416-690340

Spain - Madrid

Tel: 34-91-708-08-90 Fax: 34-91-708-08-91 **UK - Wokingham**

Tel: 44-118-921-5869 Fax: 44-118-921-5820

06/25/07